

FORM PTO-1595  
HSML-12109 (005USW)

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PATENTS ONLY

U.S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

To the Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Seung Bum Park  
Hwan Jong Jang  
Sun Kon Ko  
EulHa Kim  
Sangmi Oh  
Jongmin Park

2. Name and address of receiving party(ies):

SNU R&DB FOUNDATION  
San 56-1, Sillim-dong, Gwanak-gu  
Seoul 151-742  
KR

Additional name(s) of conveying party(ies) attached?  Yes  No

Additional name(s) & address(es) attached?  Yes  No

3. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other:

Execution Date: May 28, 2009

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)

B. Patent No.(s)

12/481137

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Curtis B. Hamre  
Address: Hamre, Schumann, Mueller & Larson P.C.  
P. O. Box 2902  
Minneapolis, MN 55402-0902

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00

- Enclosed
- Authorized to be charged to Deposit Account No. 50-3478.

8. Please charge any additional fees or credit any overpayments to our Deposit account, number 50-3478

Statement and signature:

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9. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Curtis B. Hamre

June 9, 2009

Name of Person Signing

Signature

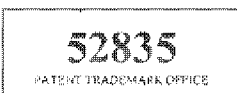
Date

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Mail documents to be recorded with required cover sheet information to:

Director of Patents and Trademarks  
Assignment Recordation Services  
P. O. Box 1450  
Alexandria VA 22313-1450

Fax: 571-273-0140



CH \$40.00 503478 12481137

Docket No.

### ASSIGNMENT OF PATENT APPLICATION

WHEREAS,

1. **PARK, Seung Bum** residing at #502, 122-i, Seoul National University Faculty Apt., Bongcheon 7-dong, Gwanak-gu, Seoul, 151-057, Republic of Korea and a citizen of Republic of Korea
2. **JANG, Hwan Jong** residing at 105-1702, Taeyoung Apt., Changcheon-dong, Mapo-gu, Seoul, 121-190, Republic of Korea and a citizen of Republic of Korea
3. **KO, Sung Kon** residing at #301, 100-196, Bongcheon 6-dong, Gwanak-gu, Seoul, 151-810, Republic of Korea and a citizen of Republic of Korea
4. **KIM, EunHa** residing at #301, 823-13, Yeoksam-dong, Gangnam-gu, Seoul, 135-080, Republic of Korea and a citizen of Republic of Korea
5. **OH, Sangmi** residing at #207-407, Samwhan Apt., Jeongwang-dong, Siheung-si, Gyonggi-do, 429-450, Republic of Korea and a citizen of Republic of Korea
6. **PARK, Jongmin** residing at #201, 1604-18, Bongcheon-7-dong, Gwanak-gu, Seoul, 151-835, Republic of Korea and a citizen of Republic of Korea

(hereinafter called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States for this invention which was filed on \_\_\_\_\_, entitled **COMPOUNDS WITH EMBEDDED BENZOPYRAN MOTIF FOR CORE STRUCTURES AND PREPARATION METHOD THEREOF** and which has been given application serial number \_\_\_\_\_; and

WHEREAS, **SNU R&DB Foundation** (hereinafter "ASSIGNEE") a nonprofit corporation organized under the laws of Republic of Korea and having an office and place of business at **San 56-1, Sillim-dong, Gwanak-gu, Seoul, 151-742, Republic of Korea** wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.


THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of

the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns, the entire right, title and interest in and to the said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.


IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

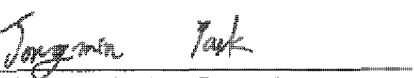
 May 28th 2009  
 Signature PARK, Seung Bum Date

 2009/5/28  
 Signature JANG, Hwan Jong Date

 2009/5/28  
 Signature KO, Sung Kon Date

 2009 / 5 / 28  
 Signature KIM, EunHa Date

 2009 / 5 / 28  
 Signature OH, Sangmi Date

 May 28th 2009  
 Signature PARK, Jongmin Date